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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Chen, Yun Lung

Serial No.: 09/750,862

Filed: 12/28/2000

For: HEAT SINK ASSEMBLY

) Examiner:
) Nihir Patel
)
) Group Art Unit: 3743
)
) Dated: April 23, 2002
)
)

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: **Commissioner of Patents and Trademarks**, Washington D.C. 20231 on this Apr. 23 2002

Signed: Wei Te Chung

Wei Te Chung

**Honorable Commissioner of Patents and Trademarks
Washington, D.C. 20231**

Sir:

In response to the outstanding Office Action dated January 23, 2002 in connection with the above-identified application, kindly amend the subject application as follows and consider the accompanying remarks.

AMENDMENT

In the claims:

Please amend claims 1, 4-6, 8-15 and 17-19, and add new claim 20 to the following. Please delete claims 2-3 and keep claims 7 and 16 unchanged.